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FEB 10 2003

January 30, 2663 NOLOGY CENTER 2800

Box NON-FEE AMENDMENT Commissioner For Patents Washington, D.C. 20231

Application No.:

09/895,501

Confirmation No.:

7243

First Inventor:

Donald Craig Foster

Filing Date:

June 29, 2001

Group Art Unit:

2827

David E. Graybill

Atty. Docket No.:

Examiner:

Title:

M-11315 US

Leadframe Having Fine Pitch Bond Fingers Formed Using Laser Cutting Method

Assignee:

Amkor Technology, Inc.

Dear Sir:

Transmitted herewith are the following documents in the above-identified application:

(1) Return Receipt Postcard;

(2) This Transmittal Letter (in duplicate);

(3) Response to Office Acton Mailed 1/17/03 (2 pp.).

The fee has been calculated as shown below: \boxtimes

CLAIMS AS AMENDED

	Claims Remaining After Amendment		Highest No. Previously <u>Paid For</u>	_	Present Extra		Rate		Additional Fee
Total Claim	s 34	Minus	41	=	0	х	\$18.00	\$	0.00
Indepe	endent	Minus	5	=	0	х	\$84.00	\$_	0.00
Fee of \$ for the first filing of one or more multiple dependent claims							\$		
一一	Fee for Request for Extens		_ month(s))					\$	
市	Fee for								
Total additional fee for this Amendment:								\$	0.00
\boxtimes	Please charge our Deposit Account No. 19-2386 in the amount of							\$	0.00
\boxtimes	Commissioner is authorized to deduct the necessary fee from Deposit Account No. 19-2386.								
Also, charge any additional fees required and credit any overpayment to our Deposit Account No. 19-2386.									

EXPRESS MAIL LABEL NO:

EV 160 615 980 US

Respectfully submitted,

James E. Parsons Attorney for Applicants Reg. No. 34,691

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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San Jose, California January 30, 2003

BOX NON-FEE AMENDMENT COMMISSIONER FOR PATENTS Washington, D. C. 20231

RESPONSE TO OFFICE ACTION MAILED 1/17/03

Dear Sir:

The following amendments and remarks are in reply to the Office Action dated January 27, 2003.

IN THE SPECIFICATION

Please add the following paragraph to the Specification at page 3, between paragraphs 14 and 15.

FIG. 7 is a plan view of a portion of a leadframe with a second alternative bond finger shape.

LAW OFFICES OF SKJERVEN MORGILL LLP San Jose, CA